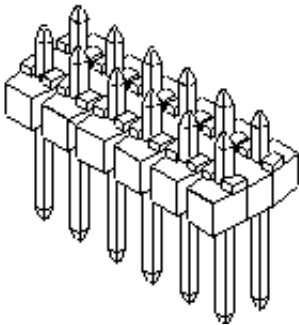




Part Number : [901310761](#)
Product Description : 2.54mm Pitch C-Grid III Header, Dual Row, Vertical, 2 Circuits, Tin (Sn) Plating
Series Number : 90131
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

[Drawing 901310761_sd.pdf](#)
[Packaging Design Drawing PK-90131-0001-000.pdf](#)

3D Models and Design Files

[3D Model 901310761_stp.zip](#)

Specifications

[Application Specification 901190001-AS-000.pdf](#)
[Product Specification PS-99020-0001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

[Multiple Part Product Compliance Statements](#)

- Eu RoHS
- REACH SVHC
- Low-Halogen

[Multiple Part Industry Compliance Documents](#)

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	90131
Description	2.54mm Pitch C-Grid III Header, Dual Row, Vertical, 2 Circuits, Tin (Sn) Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Family	C-Grid III Interconnects
Product Name	C-Grid III
UPC	800753697379

Agency

CSA	LR19980
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Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	350V AC/DC

Physical

Breakaway	Yes
Circuits (Loaded)	2
Circuits (maximum)	2
Color - Resin	Black
First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	No

Keying to Mating Part	None
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Polyester
Net Weight	0.119/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PC Tail Length	2.90mm
PCB Locator	No
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	Yes
Temperature Range - Operating	-55° to +125°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	3
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	235

Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid III Vertical Dual Row PC Board Connectors	<u>90151</u>
C-Grid III Right-Angle Dual Row PC Board Connectors	<u>90152</u>

C-Grid III Dual Row Crimp Housings	<u>90142</u>
C-Grid III Modular Dual Row Crimp Housings	<u>90143</u>

This document was generated on Jan 24, 2024